03/20/

Satent Application of:

Charles F. Chesney et al.

SENSOR AND METHOD FOR SENSING ARTERIAL PULSE PRESSURE

Triey Docket No.:

120.010US1

E Z.

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Assistant Commissioner for Patents

Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

X Utility Patent Application under 37 CFR § 1.53(b) comprising:

- X Specification (<u>28</u> pgs, including claims numbered <u>1</u> through <u>20</u> and a <u>1</u> page Abstract).
- \underline{X} Formal Drawing(s) ($\underline{20}$ sheets).
- \underline{X} Signed Combined Declaration and Power of Attorney ($\underline{4}$ pgs).
- \underline{X} Check in the amount of $\underline{\$395.00}$ to pay the filing fee.
- X Assignment of the invention to <u>Hypertension Diagnostics</u>, Inc. (<u>5</u> pgs) and Recordation Form Cover Sheet.
- \underline{X} Check in the amount of \$40.00 to pay the Assignment recording fee.
- X Small Entity Statement ($\underline{1}$ pg).

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